

Distributed Intelligent Sensing and Control (DISC) for Automotive Factory Automation.

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 This project is part of the Canadian AUTO21 Networks of Centres of Excellence: a nation-wide, interdisciplinary research effort that is focused on automotive research. Our contribution to AUTO21 is a collaborative venture between researchers at the University of Windsor, the University of Calgary, and the University of Western Ontario and spans the disciplines of micro-sensor design, embedded real-time control, and agent based systems.

DISC: Definition & Challenges

- An application of WSN to the lowest level of factory automation systems,
 - How to exploit IEC61499 to integrate WSN with extant systems that monitor and control shop floor resources.
- Challenges:
 - Harsh, uncertain, dynamic shop conditions.
 - Integration with new control software approaches to realize the flexibility and responsiveness of the whole system.

THE WSN MIDDLEWARE

- The integration of WSN technology with extant factory automation systems is of key importance.
- An interface or *middleware is required that can help*
 - hide the complexity and heterogeneity of the underlying hardware and network platforms,
 - ease the management of system resources,
 - and increase the predictability of applications.
- It basically bridges the gap between the application level and network standards



A distributed intelligent sensing and control (DISC) architecture for factory automation

- The middleware is built in two platforms:
 - sensor network ad hoc protocol platform
 - sensor network implementation platform
- Key features desired for these two platforms are:
 - the plug-and-participate architecture
 - event-driven data process



SNIP Level and IEC61499

- There is a direct mapping between IEC 61499 devices and WSN sensor nodes:
 - At the sensor node implementation platform (SNIP), sensor nodes are represented by IEC 61499 devices that are linked by a WSN.
 - Embedded node intelligence is supported by IEC 61499 function block applications (FBA).



TESTBED IMPLEMENTATION

- To validate proposed DISC approach for factory automation and algorithms at SNIP level, a testbed implementation is being conducted at University of Calgary using:
 - TelosB wireless sensor motes,
 - TinyOS-2.x open source operating system,
 - and IEC 61/100 function blocks



Platform-level Information Processing

- Device Manager and Application Manager are designed to responsible for Plug-and-participate and Event-driven data processing respectively.
- To implement these two task modules, we propose the IEC 61499 function block model for distributed process measurement and control.
- Even-driven and modularity features of the TinyOS at the physical device level combined with IEC 61499 function blocks at platform level appears to be a logical match.
- More specifically, TinyOS nesC (network embedded system C) components have a direct parallel with IEC 61499 basic function blocks:
 - both encapsulate state and couple state with functionality.
 - As well, like the IEC 61499 execution model, nesC is event-driven.

FB vs. TinyOS

